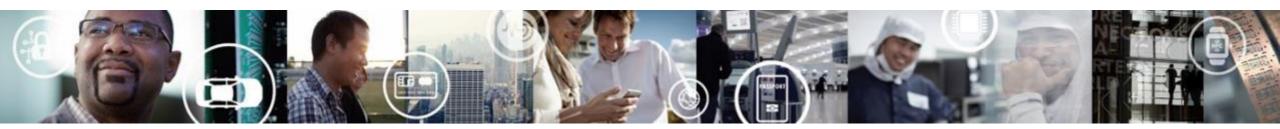
i.MX 7ULP

ULTRA LOW POWER PLATFORM FOR PORTABLE APPLICATIONS





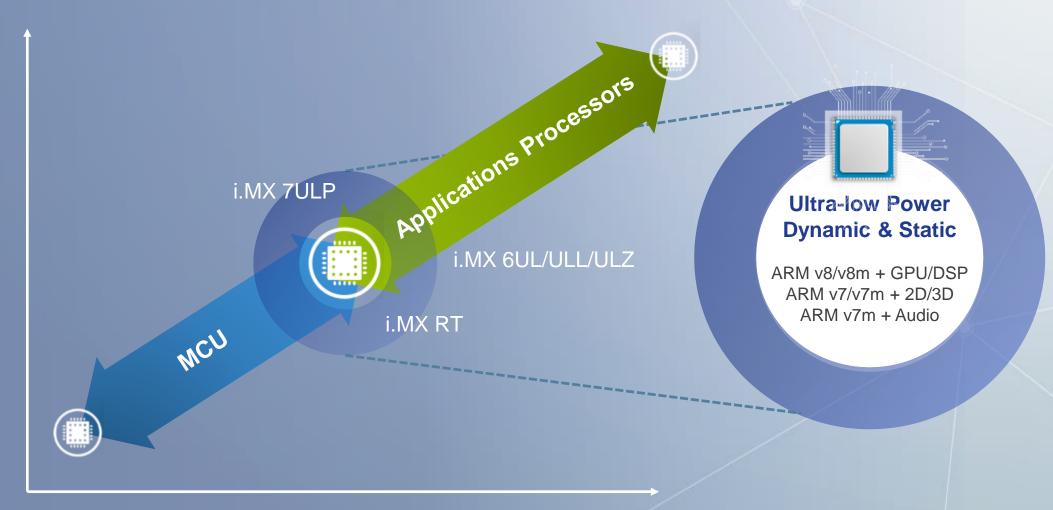
SECURE CONNECTIONS FOR A SMARTER WORLD

EXTERNAL USE

ULP Family: Market Opportunity in Power Efficiency

| 6QuadPlus | | i.MX 8 series Advanced Graphics | M4 | |
|-----------------------|----|---|-------------|--|
| 6Quad | | Auvanceu Graphics | | amazon |
| 6DualPlus | | i.MX 8M series Advanced Audio and | M4 Video | |
| 6Dual | | | | |
| 6DualLite | | i.MX 8X series | M4 | |
| 6Solo | | BOM and Energy Eff | iciency | ARM [®] v8-A (32-Bit / 64-Bit) |
| 6SoloX | M4 | | | |
| 6SoloLite | | i.MX 7 | M4 | ARM [®] v7-A (32-Bit) |
| 6SLL | | Flexible Efficient Cor | nnectivity | 09:30 |
| 6UltraLite | | i.MX 7ULP | M4 | |
| 6ULL | | Ultra Low Power with | n Graphics | |
| ARM [®] v7-A | | | | |

SCALABILITY OF EMBEDDED PROCESSING THE NEW NORMAL



HETEROGENEOUS PROCESSING: PROVIDING SOLUTIONS TO MARKET CHALLENGES



task

maximum amount of silicon

i.MX 7ULP Key Highlights

i.MX 7ULP

Bringing together Apps Processor performance and MCU Low Power





• FDSOI

- Effective control of the transistor channel through biasing
- High Performance/mW extending battery life for portable devices.
- Performance on Demand
 with fast wake up times

Efficient 3D & 2D Graphics

GC7000 nanoULTRA

OpenGL ES 2.0/1.1
 OpenVG 1.1

GC320 2D Composition

Offloads tasks from 3D GPU
Stretch/Shrinking, rotation, GUI processing



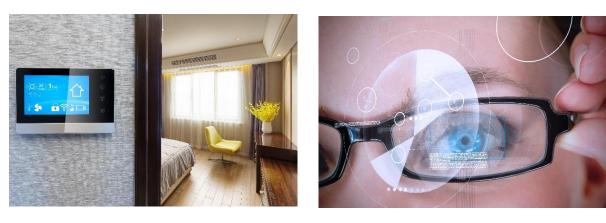
Heterogeneous Domain Computing

- Multiple software execution:
 - Powerful processing using Cortex-A7 and Neon co-processor
 - Real-time performance through
 Cortex-M4
- System integrity and security
 - Resource Domain Controller
 - Fast Low Power Boot
 - Safe Recovery of Application domain



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Target Applications





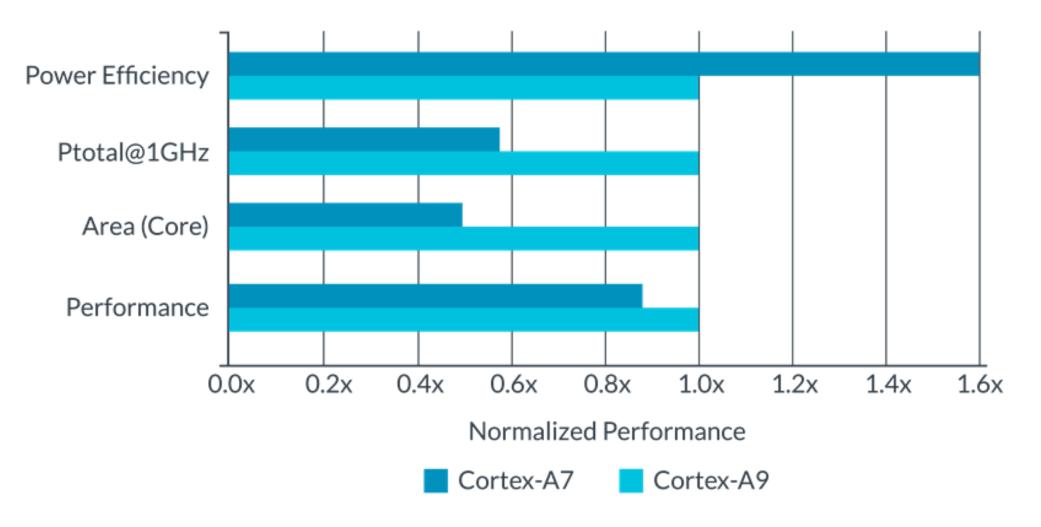




- Wearables
- Home Control
- Portable Healthcare
- Portable Printing
- Gaming Accessories
- General Embedded
 Control
- IoT Edge



Cortex-A7 enables power efficiency





i.MX 7ULP Applications Processor

Specifications:

CPU:

- Cortex-A7 @ 720MHz
- Cortex-M4 @ 200Mhz

Process: 28nm FD-SOI

Package:

- 14x14 393BGA, 0.5mm pitch: Consumer & Industrial
- 10x10 361BGA, 0.5mm pitch: Consumer Only

Temp Range (junction):

Industrial: -40C to +105C Consumer: 0C to +95C

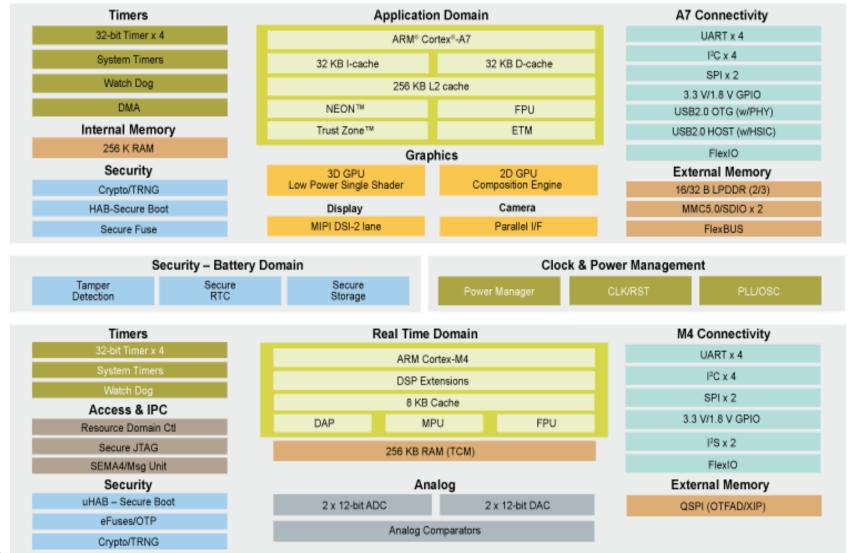
Key Features:

- Graphics
 - GC7000 nanoULTRA GPU: OpenGL 2.0 / OpenVG
 - GC320 Composition Engine
- Ultra Low Power
 - Independent Real-time domain
 - Ultra Low Run Current
- Memory options
 - QSPI (on the fly decryption)
 - 32-bit LPDDR2/3 @380MHz
 - eMMC 5.0 /SD3.0
- Connectivity
 - USB HS OTG with PHY
 - USB HS HOST HSIC
 - I2C X 8, SPI X 4, UART X 8, SDIO X 2, I2S X 2
- Security

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- High Assurance Boot
- Crypto Acceleration: AES-128/256, SHA-1, SHA-224, SHA-256
- RNG and Tamper Detection







28nm FD SOI

Power – Performance Benefits

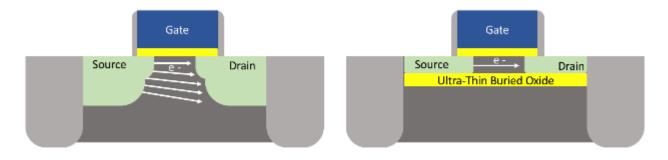
- Improved electrostatics enables shorter gate lengths
- Reduced device parasitics
- Device back bias allows for **lower Vdd** while maintaining performance
- **Device tuning** with back biasing to compensate process variation

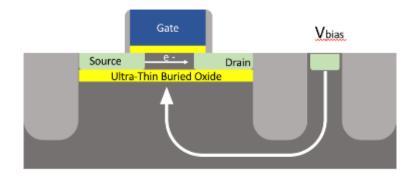
Analog Integration and Performance Benefits

- Higher gain, better matching and lower 1/f noise
- Gate first integration removes density rules for precision analog

Better SER and Latchup Immunity

- 10-100x better SER performance versus 28nm bulk alternatives
- Thin buried oxide layer makes device immune to latchup





Body Biasing: Faster when required and more energy efficient when performance isn't as critical



NXP Complete Solutions

+

i.MX7 ULP Family Processors

- **720 MHz** Cortex[™]-A7
 - NEON[™] coprocessor
- ARM[®] Cortex[™]-M4,
- Targeting a broad range of Low Power Applications that rely on a multitude of Low power states to extend battery life to its fullest.

PF1550 PMIC

- Integration of NXP's PMIC chip set with i.MX processor for optimization of power efficiency and software/hardware integration
- One-stop customer service and support during development phase to enable the design process

Sensors

- MEMS gyroscopes for reliable sensing and measuring
- Magnetometers: measuring the magnitude and direction of magnetic fields
- Pressure Sensing Devices, composed of single silicon, piezoresistive devices

ULP EVK Development Platform

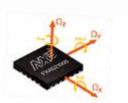
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Development platform:

- SOM based evaluation kit
- Linux[®] and Android[™] Board Support Packages are available through NXP









A Single Solution for Streamlined Performance

+



i.MX WiFi & Bluetooth Strategy

3 companies partnering to deliver world-class solutions for connected products





#1 market share for WiFi & Bluetooth modules

- Out-of-box processor and wireless connectivity for Linux and Android based systems
- Wi-Fi (802.11bgn, abgn, abgn/ac) & Bluetooth Smart Ready Options



i.MX 7ULP SOM Based Platform

- Enables fast use case evaluation through quick builds of of customized base boards.
- Allows customers to leverage the critical features of SOM design including DDR and PMIC design/layout.
- Design Files provided
 - Schematics
 - -Layout
 - -BOM



Part Numbers: i.MX 7ULP Family

All parts are orderable now and shipment is expected to start in Jun 2019 (Consumer) /Q3 2019 (Industrial)

| Part number | Qual tier | Package | Main CPU | On-chip SRAM | Real-time companion CPU | Real-time companion CPU: Tightly-coupled memory | 2D & 3D GPU | I ² S | SPI | UART | I ² C | USB | Temperature range |
|-----------------|------------|---------------|--------------------------|--------------|----------------------------|--|-------------|------------------|-----|------|------------------|--|----------------------|
| MCIMX7U5DVP07SC | Consumer | MAPBGA 393 | ARM Cortex-A7 720 MHz | 256 KB | ARM Cortex-M4 200 MHz | 256 KB | Y | 4 | 4 | 8 | 8 | USB 2.0 OTG +PHY, USB 2.0 Host +HSIC | 0-95°C |
| MCIMX7U5DVK07SC | Consumer | VFBGA 361 | ARM Cortex-A7 720 MHz | 256 KB | ARM Cortex-M4 200 MHz | 256 KB | Y | 4 | 4 | 8 | 8 | USB 2.0 OTG +PHY, USB 2.0 Host +HSIC | 0-95°C |
| MCIMX7U3DVK07SC | Consumer | VFBGA 361 | ARM Cortex-A7 720 MHz | 256 KB | ARM Cortex-M4 200 MHz | 256 KB | - | 4 | 4 | 8 | 8 | USB 2.0 OTG +PHY, USB 2.0 Host +HSIC | 0-95°C |
| MCIMX7U5CVP06SC | Industrial | MAPBGA 393 | ARM Cortex-A7 650 MHz | 256 KB | ARM Cortex-M4 200 MHz | 256 KB | Y | 4 | 4 | 8 | 8 | USB 2.0 OTG +PHY, USB 2.0 Host +HSIC | -40-105°C |
| MCIMX7U3CVP06SC | Industrial | MAPBGA 393 | ARM Cortex-A7 650 MHz | 256 KB | ARM Cortex-M4 200 MHz | 256 KB | - | 4 | 4 | 8 | 8 | USB 2.0 OTG +PHY, USB 2.0 Host +HSIC | -40-105°C |





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